| ASSOCIATION CONNECT<br>ELECTRONICS INDUSTR                 | Material Composit<br>© Copyright 2005. IPC, I<br>international and Pan-An                            | Bannockb                  | urn, Illinois. A          | ll rights reserved untions. | under both                               | This docum<br>level parts, t                                    | ent is a decla<br>the declaratio | ration of the | e substance<br>sses all low | s within the<br>er level mate   | manufacture<br>erials for wh | rer listed it<br>hich the m | em. Note: i<br>anufacture | f the item is an a<br>has engineering | ssembly with lower responsibility. |
|--|--|---------------------------|---------------------------|-----------------------------|--|---|----------------------------------|---------------|-----------------------------|---------------------------------|------------------------------|-----------------------------|---------------------------|---------------------------------------|------------------------------------|
| 1752-21.1  | IPC Web Site for Information on IPC-1752 Standard Form Type * http://www.ipc.org/IPC-175x Distribute |                           |                           |                             | k  | Declaration Class *<br>Class 6 - RoHS Yes/No. Homogeneous Mater |                                  |               |                             |                                 | ale and Mfg Information      |                             |                           |                                       |                                    |
| Supplier Inform  |  |                           |                           |                             |  |   |                                  |               |                             | .,8                             |                              |                             | <u>e</u>                  |                                       |                                    |
| Company name*  |  |                           | Company unique ID         |                             |  | Unique ID Authority   |                                  |               |                             |                                 | Response Date*               |                             |                           |                                       |                                    |
| onsemi   |  |                           |                           |                             |  |   |                                  |               |                             |                                 | 2025-06-03                   |                             |                           |                                       |                                    |
| Contact Name   |  | Title - Contact           |                           |                             |  | Phone - Contact*  |                                  |               |                             | Email - Contact*                |                              |                             |                           |                                       |                                    |
| Product-Env-Stev   | vards  | Product Enviro Compliance |                           |                             |  | NA  |                                  |               |                             | Product-Env-Stewards@onsemi.com |                              |                             |                           |                                       |                                    |
| Authorized Representative*                                 |  |                           | Title - Representative    |                             |  | Phone - Representative*   |                                  |               |                             | Email - Representative*         |                              |                             |                           |                                       |                                    |
| Product-Env-Stewards                                       |  |                           | Product Enviro Compliance |                             |  | NA  |                                  |               |                             | Product-Env-Stewards@onsemi.com |                              |                             |                           |                                       |                                    |
| Reques   | Requester Item Number Mfr Item   |                           |                           | Number Mfr Item Name        |  |   | Effective D                      | ate Versi     | on                          | Manufacturing Site              |                              | V                           | Veight*                   | UOM                                   | Unit Type                          |
|  |  |                           |                           |                             | SONANT CONTROLLER 2025-<br>ALLEY LOCKOUT |   | 2025-06-03                       | ;             |                             | TH6                             |                              | 7                           | 6.13                      | mg                                    | Each                               |
| Manufacturing  | g Proccess Information   | I                         |                           |                             |  |   |                                  |               |                             |                                 |                              |                             |                           |                                       |                                    |
| Terminal Plating / Grid Array Material Terminal Base Alloy |  |                           | Alloy                     | J-STD-020 MSL               | Rating                                   | Peak P  | rocess Body                      | / Temperat    | ure Max Tii                 | ne at Peak '                    | Temperatu                    | ure Numb                    | er of Reflow Cy           | cles                                  |                                    |
| Matte Tin (Sn) - annealed CU Alloy                         |  |                           |                           | 1                           |  | 260   |                                  | С             | 30                          |                                 | second                       | ds 3                        |                           |                                       |                                    |
| Comments   |  |                           |                           |                             |  |   |                                  |               |                             |                                 |                              |                             |                           |                                       |                                    |
|  | time at peak temperature d   | 0                         | 0                         |                             |  |   |                                  |               |                             |                                 |                              |                             |                           |                                       |                                    |
| or more information  | tion regarding material com  | position <b>j</b>         | please refer to           | page 3                      |  |   |                                  |               |                             |                                 |                              |                             |                           |                                       |                                    |

| RoHS Material Composition Declaration  |  |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |  |
|--|--|--|---|---|---|--|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  |  |  |   |   |   |  |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>y others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and cc<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa  | ances per the definitio  | on above  | Supplier Acceptance                             | * Accepted  |  |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per   | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU   |  |   |   |   |  |  |  |  |  |  |  |
| Declaration Signature  |  |  |   |   |   |  |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester  | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska  | Le   |   |   |   |  |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| sigma range of distribution unless otherwise noted). |        |                 |          |  |                  |        |         |                 |  |
|--|--------|-----------------|----------|--|------------------|--------|---------|-----------------|--|
| Homogeneous Material                                 | Weight | Unit of Measure | Level    | Substance  | CAS              | Exempt | Weight  | Unit of Measure |  |
| Die  | 2.62   | mg              | Supplier | Silicon (Si)   | 7440-21-3        |        | 2.62    | mg              |  |
| Die Attach   | 0.39   | mg              | Supplier | Epoxized Condensate Of Para-<br>Hydrobenzaldehyde And Alkyl Phenol | 129915-35-1      |        | 0.078   | mg              |  |
|  |        |                 | Supplier | Silver (Ag)  | 7440-22-4        |        | 0.312   | mg              |  |
| Lead Frame   | 21.32  | mg              | Supplier | Silver (Ag)  | 7440-22-4        |        | 0.3624  | mg              |  |
|  |        |                 | Supplier | Zinc (Zn)  | 7440-66-6        |        | 0.0256  | mg              |  |
|  |        |                 | Supplier | Iron (Fe)  | 7439-89-6        |        | 0.501   | mg              |  |
|  |        |                 | Supplier | Copper (Cu)  | 7440-50-8        |        | 20.4246 | mg              |  |
|  |        |                 | Supplier | Phosphorus (P)   | 7723-14-0        |        | 0.0064  | mg              |  |
| Mold Compound-Black                                  | 50.28  | mg              |          | Epoxy Phenol Resin   | proprietary data |        | 5.2794  | mg              |  |
|  |        |                 | Supplier | Fused Silica (SiO2)  | 60676-86-0       |        | 45.0006 | mg              |  |
| Plating  | 1.37   | mg              | Supplier | Tin (Sn)   | 7440-31-5        |        | 1.37    | mg              |  |
| Wire Bond - Au                                       | 0.15   | mg              | Supplier | Gold (Au)  | 7440-57-5        |        | 0.15    | mg              |  |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 signa range of distribution unless otherwise noted).